EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	33	colloidal with metal with porous with substrate	US-PGPUB; USPAT	OR	ON	2007/09/06 16:09
S2	5065	colloidal with metal with solution	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:10
S3	181	S2 and film and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:31
S4	4257	metal adj (colloid$2 or sol)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34
S5	0	S4 and (conductive adj film) and (porous adj substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S6	8	S4 and (conductive adj film) and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S7	226	S4 and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34
S8	48674	porous with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57

S9	218	S8 and (colloid$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S10	58	S9 and (conduct$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S11	14039	porous adj substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S12	56	S11 and (colloid$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S13	10	S12 and (conduct$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S14	250	(organic with semiconductor) and (porous with electrode)	USPAT	OR	ON	2007/09/08 17:33
S15	26	(organic with semiconductor) and (porous adj electrode)	USPAT	OR	ON	2007/09/08 17:33
S16	5960	metal with colloid	US-PGPUB; USPAT	OR	ON	2008/02/04 15:02
S17	55	S16 and (metal with core) and (organic with shell)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:03
S18	1	S17 and (drying with remov$3 with organic)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:04
S19	1	S17 and (dry$3 with remov$3 with organic)	US-PGPUB; USPAT	OR	ON	2008/02/04 15:05

S20	49	S17 and dry$3	US-PGPUB; USPAT	OR	ON	2008/02/04 15:10
S21	651	(metal$4 with colloid) and (organic with (solvent or substance)) and (dry $3 with (air or infrared))	US-PGPUB; USPAT	OR	ON	2008/06/11 12:33
S22	141	S21 and (electrical$5 with conductive)	US-PGPUB; USPAT	OR	ON	2008/06/11 12:37
S23	3752	metal with colloid	USPAT	OR	ON	2008/12/24 16:38
S24	1	("7398365").PN.	USPAT	OR	OFF	2008/12/27 16:43
S25	1	("7348365").PN.	USPAT	OR	OFF	2008/12/27 16:44
S26	4	("4629709" | "5431967" | "5560960" | "5912069").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/27 16:55
S27	53	Nakatani.IN. and colloid$3	US-PGPUB; USPAT	OR	ON	2008/12/27 16:57
S28	44	S27 and metal	US-PGPUB; USPAT	OR	ON	2008/12/27 16:57
S29	627	metal with colloid$3 with ink	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/27 17:07
S30	63	metal with colloid$3 with stabilization	USPAT	OR	ON	2008/12/27 17:40
S31	135	metal with colloid$3 with ink	USPAT	OR	ON	2008/12/28 16:59
S32	64	S31 and (polymer with coat$3)	USPAT	OR	ON	2008/12/28 17:01
S33	1	"4116910".PN.	USPAT; USOCR	OR	OFF	2008/12/29 10:53
S34	1	("6730400").PN.	USPAT; USOCR	OR	OFF	2008/12/30 11:57

12/30/2008 1:16:32 PM
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